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Electrically and Mechanically Tunable Electron Spins in Silicon Carbide Color Centers

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The electron spins of semiconductor defects can have complex interactions with their host, particularly in polar materials like SiC where electrical and mechanical variables are intertwined. By combining pulsed spin resonance with *ab initio* simulations, we show that spin-spin interactions in 4H-SiC neutral divacancies give rise to spin states with a strong Stark effect, sub-10⁻⁶ strain sensitivity, and highly spin-dependent photoluminescence with intensity contrasts of 15%–36%. These results establish SiC color centers as compelling systems for sensing nanoscale electric and strain fields.

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Silicon carbide is increasingly recognized as a potential material host for quantum-information and sensing technologies that leverage advanced semiconductor processing alongside solid-state spin control [1–9]. Much like nitrogen-vacancy (NV) centers in diamond [10], neutral divacancies in SiC have ground-state electronic spins [1,2] that exhibit optical addressability [11–14] and long spin-coherence times that persist up to elevated temperatures, even up to room temperature for certain defect forms [5,7]. The NV center in diamond is currently being developed for applications ranging from quantum communication [15] to nanoscale nuclear magnetic resonance [16,17]. The extensive uses of SiC in industry, including wafer-scale growth [18], high-power devices, and substrates for epitaxially grown GaN [19] and graphene [20], could propel such applications and many others [21–23] forward. Underlying the success of such advancements will be an improved understanding of how spins in semiconductor defects interact with their host crystal.

In this Letter, we demonstrate that the spin states of neutral divacancies and related defect states in 4H-SiC are highly sensitive to electrical and mechanical perturbations of their host. Their electric field response is 2–7 times stronger than that [24,25] of NV spins in diamond, and they exhibit significant spin-dependent photoluminescence (PL) contrast for high-fidelity spin readout. Moreover, ac strain-sensing protocols demonstrated here lead to an optimized sensitivity projected to be in the 10⁻⁷/√Hz·N range, where *N* is the number of interrogated spins. Although electric- and strain-field effects on SiC spins are interrelated due to SiC's piezoelectricity, our *ab initio* simulations disentangle these two effects and attribute the strong spin response to electric fields to the high electron polarizability

in SiC. Because our techniques are based on point defects and measure intrinsic quantities, their applicability extends down to the nanometer scale. In the future, they could be applied towards sensing intracellular electric fields, integrating nanoscale sensing into SiC bioelectronics [26], or coupling spins to SiC nanomechanical resonators [27].

Neutral divacancies, consisting of neighboring C and Si vacancies, exist in four inequivalent forms in 4H-SiC, distinguished by whether vacancies are located on the hexagonal (*h*) or quasicubic (*k*) lattice sites [5]. These forms have been alternatively labeled as PL1–PL4 [5,7], P6/P7 centers (in electron paramagnetic resonance studies) [1,2,28], and the UD2 lines (in PL studies) [12]. Their electronic ground states are spin triplets and described by the Hamiltonian [24,29]:

$$H = hD\sigma_z^2 + g\mu_B\boldsymbol{\sigma} \cdot \mathbf{B} - E_x(\sigma_x^2 - \sigma_y^2) + E_y(\sigma_x\sigma_y + \sigma_y\sigma_x), \quad (1)$$

where the defect axis is aligned along *z*, *h* is Planck's constant, *g* = 2.0 is the electron *g* factor, μ_B is the Bohr Magneton, $\boldsymbol{\sigma}$ is the vector of spin-1 Pauli matrices, *B* is the magnetic field, and *D*, *E_x*, and *E_y* are the zero-magnetic-field splitting parameters. These terms can be expanded as $D = D^0 + d_{\parallel}F_z + e_{\parallel}\epsilon_z$ and $E_{x,y} = E_{x,y}^0 + d_{\perp}F_{x,y} + e_{\perp}\epsilon_{x,y}$, where the *D*⁰ and *E*_{*x,y*}⁰ terms are the crystal-field splittings in the absence of applied strain and electric fields, *d*_∥ and *d*_⊥ are the Stark-coupling parameters of the ground-state spin to an electric field (*F*) that is, respectively, parallel and perpendicular to the defect axis, *e*_∥ and *e*_⊥ are the strain-coupling parameters, and $\boldsymbol{\epsilon}$ is the effective strain field defined in Ref. [29]. PL1 and PL2 (the *hh* and *kk* divacancies, respectively) are oriented along the SiC

FIG. 1 (color). (a) A 4H-SiC membrane is epoxied to the top of a piezo actuator, which applies strain to the SiC membrane as it stretches. (b) PL spectra as a function of V_{piezo} (strain) at $T = 20$ K, showing that the optical transitions of SiC defects can be tuned with strain. The applied strain splits the ZPL optical transitions, with the c axis-oriented defects (PL1, PL2, and PL6) bifurcating and the basal-oriented defects (PL3, PL4, and PL5) trifurcating. (c) Polarization dependence of the PL from the strain-split ZPL branches, measured at the points indicated by purple circles in (b). The analyzed polarization is in the plane perpendicular to the c axis.

c axis and have C_{3v} symmetry (i.e., $E_{x,y}^0 = 0$). PL3 and PL4 (the hk and kh divacancies, respectively) are oriented along basal planes, at 109.5° from the c axis. This orientation reduces their symmetry to C_{1h} , resulting in nonzero $E_{x,y}^0$ and thus broken degeneracy between all three spin sublevels at zero magnetic field.

Our experiments use high-purity semi-insulating 4H-SiC wafers, purchased from Cree Inc., in which neutral divacancies are incorporated during crystal growth. We thinned 500 μm -thick chips of SiC down to 50 μm -thick membranes and used epoxy to mount them on top of piezo actuators, which are, in turn, mounted to copper cold fingers for cryogenic operation. The neutral divacancies' zero-phonon line (ZPL) optical transitions can be seen as peaks in their PL spectra [12] when we illuminate a SiC membrane with 1.27 eV light at a temperature $T = 20$ K. Each inequivalent divacancy has a distinct ZPL energy ranging from 1.0 – 1.2 eV. In addition, two other observed species (labeled PL5 and PL6) have similar optical and spin transition energies to the neutral divacancies [5], but the defects with which they are associated have not been identified.

Microwave radiation for electron spin resonance is supplied by waveguide antennae on the chip or below the sample [5,7]. The piezo actuation applies tensile strain to the SiC membrane transverse to the c axis [Fig. 1(a)], an estimated 5×10^{-7} strain/ $V_{\text{piezo}} \pm 40\%$ (see the Supplemental Material [30]), where V_{piezo} is the voltage applied to the piezo. Controls assure that electric fields within the measurement volume due to V_{piezo} are too weak to interfere with any measurements.

As strain is applied, the energy of each defect species' ZPL splits and shifts as much as 2.3 meV, or 550 GHz

[Fig. 1(b)]. The ZPLs corresponding to the c axis-oriented defects bifurcate, with the two resulting branches having orthogonally polarized PL [Fig. 1(c)]. This splitting, approximately 12 eV/strain, reflects the reduction of the C_{3v} symmetry of the c axis-oriented defects, whose doubly degenerate excited state orbitals at zero strain are predicted [2] to closely match the structure of NV centers in diamond [31,32]. In contrast, the basal-oriented defects have highly split ZPLs even at zero strain due to the crystal field. Each ZPL branch of the basal-plane-oriented defects trifurcates as strain is applied, with the polarization from each branch offset by 120° . This splitting indicates that, as expected, strain breaks the symmetry between orientations of defects in the basal plane that are equivalent at zero strain.

Applying transverse strain to the SiC membrane also shifts the defect's electronic spin transition energies. We measure these shifts with optically detected magnetic resonance (ODMR). Here, we read out the ground-state spin by exploiting the defects' spin-dependent ($m_s = 0$ vs $m_s = \pm 1$) PL intensity (I) and monitoring the changes to $I(\Delta I)$ as an applied microwave field rotates spins via electron spin resonance [5,7]. The ΔI resonances as the frequency of the applied microwave field is swept correspond to spin transition energies [Fig. 2(a)].

As we apply uniaxial strain transverse to the c axis, the average frequency of the two $\Delta m_s = \pm 1$ spin transitions shift [Fig. 2(a)], corresponding to a D -term shift of the spin Hamiltonian (Eq. 1). Although we observe dc spin resonance shifts of up to 0.8 MHz, the resolution of dc-strain detection [29] is constrained by relatively broad $1/T_2^*$ spin-resonance linewidths, where T_2^* is the inhomogeneous spin-dephasing time (1.5 μs for these defects [5]).

FIG. 2 (color). (a) Strain sensing using dc ODMR of divacancy spins in SiC (T_2^* limited) at $T = 20$ K. A strain-induced 0.8 MHz shift to the PL2 spin transition energies is observed, with the split peak within each curve due to a stray B field of 0.35 G. (b) The Hahn-echo pulse scheme used for T_2 -limited ac strain sensing. During the t_{free} evolution periods, $\pm V_{\text{piezo}}$ pulses phase shift the spin superposition. The final pulse of the Hahn-echo sequence projects this phase onto a measurable spin population difference. (c) ac strain sensing data for the neutral divacancies, with $t_{\text{free}} = 100 \mu\text{s}$, $t_{\text{pulse}} = 80 \mu\text{s}$, $T = 20$ K, and $B = 0$. The fits are to single exponentially decaying sine curves and have frequencies of 0.07 V^{-1} , 0.07 V^{-1} , 0.12 V^{-1} , and 0.16 V^{-1} for PL1–PL4, respectively. The three curves are offset from the origin for clarity.

We developed an ensemble ac sensing technique that leverages the much longer homogeneous coherence time (T_2) of SiC divacancies (up to $360 \mu\text{s}$ [7]) to enable more sensitive strain measurements. Here, a Hahn-echo pulse sequence is applied between $m_s = 0$ and one of the $m_s = \pm 1$ spin states [7,24,33]. During the free precession segment (of total length t_{free}) of this sequence, a synchronized strain perturbation (generated by $\pm V_{\text{piezo}}$ applied to the piezo) causes a strain-induced phase to accumulate between the $m_s = 0$ and $m_s = \pm 1$ spin superposition (Fig. 2(b) and [30]). The final pulse of the Hahn-echo sequence projects this strain-induced phase shift into a spin population difference and, thus, a measurable ΔI . We normalize ΔI by ΔI_{Hahn} , the Hahn-echo signal strength with no strain applied. As strain is increased, ΔI oscillates [Fig. 2(c)] according to this phase shift, demonstrating coherent spin-based strain sensing.

Despite the large uncertainty in our strain calibration, we infer that the spin transitions of PL1–PL4 exhibit strain shifts approximately ranging from 2–4 GHz/strain, and that our ensemble measurements demonstrate sub- 10^{-6} strain sensitivity after averaging for two minutes per point. In an ideal measurement, with high optical collection and small background PL, ac strain sensing with neutral divacancies has a projected sensitivity in the $10^{-7}/\sqrt{\text{Hz} \cdot N}$

range (see the Supplemental Material [30]). Optical interferometry is a more precise technique for sensing strain in bulk samples, but it relies on measuring mechanical displacement (with sensitivities down to the 10–pm level [34]). Spin-based strain sensing should, thus, be a competitive technique for measuring strain in micro- and nanostructures, where absolute displacements are extremely small, as well as in applications involving full tensor-strain measurements [32].

To measure the SiC spin states' response to electric fields, we use the same pulse sequence as for strain measurements (Fig. 2(b) and Ref. [24]), substituting a c axis-oriented voltage applied across the SiC membrane (V_{mem}) for piezo-induced strain [Fig. 3(a)]. As in Fig. 2, ΔI oscillations are observed, in this case with increasing V_{mem} , which correspond to electric field-induced phase shifts of the spin superposition [Figs. 3(b) and 3(c)]. The basal-oriented defect spins primarily couple to the c axis electric field via $d_{\perp}$ (i.e., E term shifts in Eq. 1), resulting in mirror-image ΔI oscillations from the two $\Delta m_s = \pm 1$ spin-transition frequencies [Fig. 3(b), left] as they are split by the electric field. The c axis-oriented defects have slower ΔI oscillations [Fig. 3(c)], indicating that their $d_{\parallel}$ parameter (Table I) is significantly smaller than $d_{\perp}$ for the basal-oriented defects. Using PL5, which exhibits strong room-temperature ODMR, we show that SiC defect spins can sense electric fields at room temperature [Fig. 3(b), right].

FIG. 3 (color). (a) Electric-field sensing with divacancy and related spins in SiC. Using the same pulse sequence as in Fig. 2(b), but substituting V_{mem} for V_{piezo} , $\pm V_{\text{mem}}$ pulses are applied across a $w = 53 \mu\text{m}$ thick SiC membrane, using patterned electrodes that transmit light. As V_{mem} is increased, t_{pulse} is held constant at $80 \mu\text{s}$ (for the data at 20 K) or $20 \mu\text{s}$ (for the room-temperature data), and $B = 0$. (b) ac electric field-sensing measurements for basal-oriented defects show mirror image ΔI oscillations when the higher (blue) and lower (orange) frequency spin-resonance transitions are used (left panel). The PL5 data (right panel) are taken at room temperature. (c) Electric field sensing for the c axis oriented defects at 20 K, with the three curves vertically offset for clarity. The fits are to exponentially decaying sine curves, whose fitted frequencies are the spin-electric field coupling parameters (Table I).

TABLE I. Experimentally measured and calculated Stark parameters for the PL1–PL6 ground-state-spin Hamiltonians in 4H-SiC, in units of h Hz cm/V and a comparison to those for the NV center in diamond, with Ref. [25] used as an experimental reference for the diamond NV center. The experimental (calculated) values of $d_{\parallel}$ are compared to the experimental (calculated) value for the diamond NV center. The rightmost column is $d_{\parallel}$ calculated with only distorted ions due to the piezoelectric effect, i.e., without any extra charge polarization. The experimental uncertainty for the SiC data is 5%.

Defect/Configuration	Experiment		Theory	
	$d_{\perp}$	$d_{\parallel}$	$d_{\parallel}$	$d_{\parallel}^a$
NV center	17	0.35	0.76	
PL1 (hh)		2.65	5.2	0.38
PL2 (kk)		1.61	4.2	0.23
Ratio of PL1:NV		7.6:1	6.8:1	0.5:1
Ratio of PL2:NV		4.6:1	5.5:1	0.3:1
PL3 (hk)	32.3	<3	0.41	
PL4 (kh)	28.5	0.44	0.79	
PL5	32.5	<3		
PL6		0.96		

^aCalculated with only atom-distortion effect

Room-temperature sensitivity is a significant property for future applications such as biosensing.

An important parameter for high-fidelity sensing is the ODMR contrast (C_{defect}) between spin states, defined as the fractional change in PL due to an optically polarized spin population being flipped by $\Delta m_s = \pm 1$. We use spectrally resolved ODMR measurements to measure C_{defect} from ZPLs [Fig. 4(a)], avoiding interference from background PL. Instead of applying π pulses to flip spin states, we mix the spin populations with strong continuously applied microwave radiation and weak laser illumination.

FIG. 4 (color). (a) A plot of the ZPL intensity of PL4 without microwave radiation (blue curve) and the change in PL when strong microwave irradiation is applied to the sample (grey curve). $\Delta I_{\text{mixed}}/I$ is measured to be -0.10 , $+0.11$, -0.14 , -0.10 , -0.24 , and -0.22 for PL1–PL6, respectively. (b) Time-resolved PL from PL4 as a function of delay from an excitation laser pulse (blue dots). The decay constant of the exponential fit (black) is the optical lifetime (τ). $T = 20$ K, $B = 0$. See [30] for the calculation of C_{defect} from $\Delta I_{\text{mixed}}/I$ and for the other defect species' lifetimes and ODMR contrasts.

Calculating C_{defect} from the measured fractional change in PL intensity ($\Delta I_{\text{mixed}}/I$) requires detailed knowledge of spin mixing dynamics, but we use $3/2 \times \Delta I_{\text{mixed}}/I$ as a conservative lower bound for C_{defect} [30], which is found to range from 0.15–0.21 for the neutral divacancies (PL1–PL4), and from 0.33–0.36 for PL5 and PL6 at 20 K. These high C_{defect} values are comparable to that for the NV center in diamond, whose optimized ODMR contrast is typically around 0.3 [35,36]. The optical lifetimes of the SiC divacancies, another important quantity for spin readout, is found to range from 12–15 ns [Fig. 4(b)], also comparable to that for NV centers in diamond [35]. These favorable ODMR characteristics make SiC defects compelling systems for precision sensing.

In order to understand the interplay between strain and electric field-induced spin shifts in SiC, we carry out *ab initio* density-functional calculations of the zero-field splitting parameters in the ground-state Hamiltonian, along with electric- and strain-field perturbations to them. Since our simulations calculate spin-spin interactions between electrons localized to the defects but neglect spin-orbit coupling, we focus on the c axis-oriented divacancies, whose C_{3v} symmetry implies low spin-orbit coupling. Our simulation methodology [30] provides excellent agreement with the ground state D^0 values for the c axis-oriented divacancies in 4H-SiC as well as for the NV center in diamond (within 1.5%). As a corroboration for our simulation methods, we also verify the change in zero-field splitting due to external pressure acting on NV center in diamond (10.3 MHz/GPa (cryogenic) calculated vs 14.6 MHz/GPa (room-temperature) experiment [29]).

The experimental observation that tensile and compressive strain perpendicular to the c axis primarily shifts the D term of the Hamiltonian for the c axis oriented defects [see Fig. 2(a)] is supported by simulations. These show that this strain causes only a small deviation from C_{3v} symmetry for the defect's electronic orbitals, with their spin exhibiting a correspondingly small $E_{x,y}$ term but a larger D shift of 7 GHz/strain, neglecting Poisson effects. These magnitudes are comparable to the experimentally determined (2–4 GHz/strain) values, but both are only order-of-magnitude estimates. For c axis-oriented strain, a D shift of 5 GHz/strain is calculated.

The measured electric field-spin coupling coefficients are consistently found to be higher than those [24,25] for the diamond NV center, up to 1.9x higher for $d_{\perp}$ and 7.6x higher for $d_{\parallel}$ (Table I). While our simulations overestimate $d_{\parallel}$ in both SiC and diamond, they accurately corroborate (within 30%) the experimentally observed relative enhancement of $d_{\parallel}$ for neutral divacancies in SiC over that for diamond NV centers.

Two physical effects contribute to $d_{\parallel}$. First, electric fields distort the positions of atoms in the SiC lattice neighboring the divacancy. Second, electric fields shift the electron distribution surrounding the defect. Although these effects

occur simultaneously and cannot be distinguished by experiments alone, simulations can separate the two effects. By calculating $d_{\parallel}$ with a distorted lattice but no extra field-induced shifts to electron wave functions, we find $d_{\parallel}$ to be an order of magnitude smaller than its value when electric fields are fully turned on (Table I). Thus, direct field-induced shifts of electron wave functions are primarily responsible for the Stark-shift parameters, not the piezoelectric effect.

The enhanced Stark effect of divacancy spins in SiC over NV-center spins in diamond can be generally understood by the relative electron polarizability in the two materials. The polar crystal bonds in SiC have high electron polarizability, which can be seen by the material's high (10.0) dielectric constant. Since defect wave functions derive from dangling bond orbitals, they inherit this high polarizability. In turn, this polarizability causes a strong spin response to external electric fields.

Our results show that the spins of neutral divacancies in SiC can sensitively detect both strain and electric fields. They exhibit high optical polarization [7], high intrinsic ODMR contrasts, and a stronger response to electric fields than those of NV centers in diamond. In the future, SiC defects could also be used for temperature sensing [22,23,37–39], particularly since basal-oriented defects exhibit first-order insensitivity to magnetic fields. Moreover, the combination of the spin-strain interactions measured here and the outstanding electromechanical properties of SiC [27] makes SiC an excellent material for coupling spins to mechanical resonators [40]. These coupled systems could lead to mechanically induced spin squeezing [41], strong coupling between spins and phonons, and phonon lasing [42].

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